



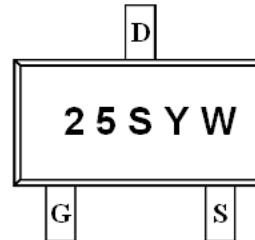
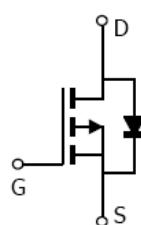
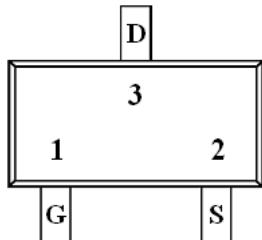
General Description

AFP2325S, P-Channel enhancement mode MOSFET, uses Advanced Trench Technology to provide excellent $R_{DS(ON)}$, low gate charge. These devices are particularly suited for low voltage power management, and low in-line power loss are needed in commercial industrial surface mount applications.

Features

- -150V/-1.4A, $R_{DS(ON)}=745\text{ m}\Omega @ V_{GS}=-10\text{V}$
- -150V/-1.0A, $R_{DS(ON)}=800\text{ m}\Omega @ V_{GS}=-6\text{V}$
- Super high density cell design for extremely low $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability
- SOT-23-3L package design

Pin Description (SOT-23-3L)



Application

- Active Clamp Circuits in DC/DC Power Supplies

Pin Define

Pin	Symbol	Description
1	G	Gate
2	S	Source
3	D	Drain

Ordering Information

Part Ordering No.	Part Marking	Package	Unit	Quantity
AFP2325SS23RG	25SYW	SOT-23-3L	Tape & Reel	3000 EA

- ※ 25S parts code
- ※ Y year code (0 ~ 9)
- ※ W week code (A ~ Z = 1 ~ 26 / a ~ z = 27 ~ 52)
- ※ AFP2325SS23RG : 7" Tape & Reel ; Pb-Free ; Halogen-Free



Absolute Maximum Ratings

($T_A=25^\circ\text{C}$ Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V_{DSS}	-150	V
Gate -Source Voltage	V_{GSS}	± 20	V
Continuous Drain Current($T_J=150^\circ\text{C}$)	I_D	-1.4	A
$T_c=70^\circ\text{C}$		-1.0	
Pulsed Drain Current	I_{DM}	-5	A
Continuous Source Current(Diode Conduction)	I_S	-1.6	A
Power Dissipation	P_D	3.2	W
$T_c=70^\circ\text{C}$		2.1	
Operating Junction Temperature	T_J	150	$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-55/150	$^\circ\text{C}$
Thermal Resistance-Junction to Ambient	$R_{\theta JA}$	120	$^\circ\text{C}/\text{W}$

Electrical Characteristics

($T_A=25^\circ\text{C}$ Unless otherwise noted)

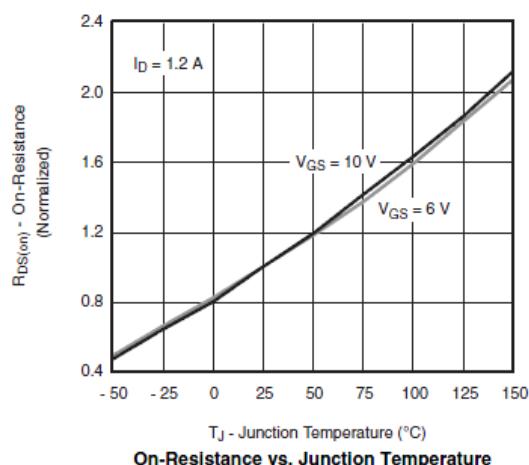
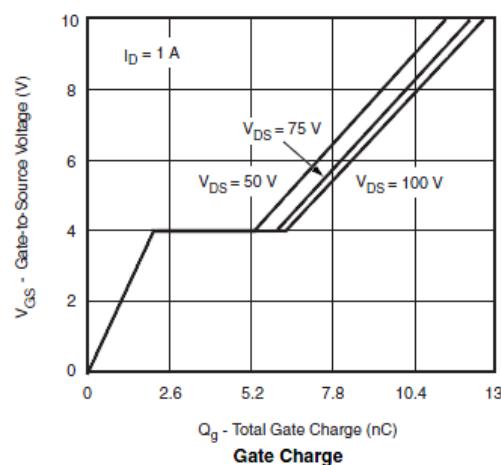
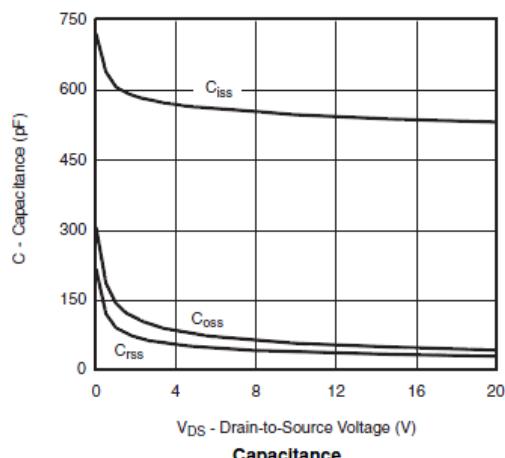
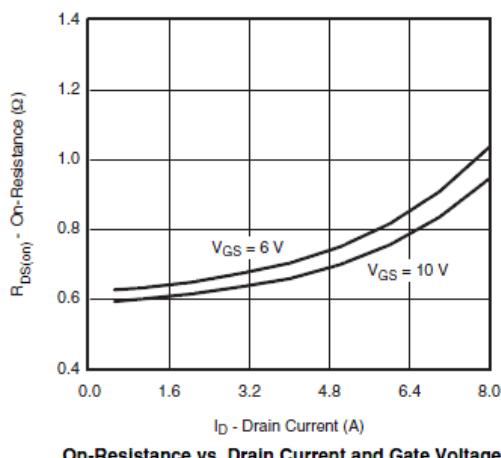
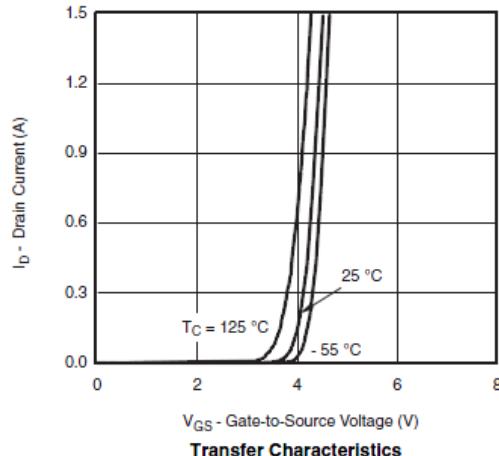
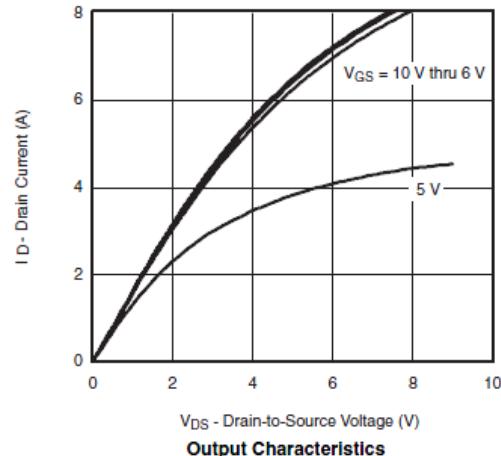
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0\text{V}, I_D=-250\mu\text{A}$	-150			V
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS}=V_{GS}, I_D=-250\mu\text{A}$	-2.0		-4.0	
Gate Leakage Current	I_{GSS}	$V_{DS}=0\text{V}, V_{GS}=\pm 20\text{V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=-120\text{V}, V_{GS}=0\text{V}$			-1	
		$V_{DS}=-120\text{V}, V_{GS}=0\text{V}$ $T_J=85^\circ\text{C}$			-30	uA
On-State Drain Current	$I_{D(\text{on})}$	$V_{DS} \geq -10\text{V}, V_{GS}=-10\text{V}$	-3			A
Drain-Source On-Resistance	$R_{DS(\text{on})}$	$V_{GS}=-10\text{V}, I_D=-1.4\text{A}$		675	745	$\text{m}\Omega$
		$V_{GS}=-6\text{V}, I_D=-1.0\text{A}$		730	800	
Forward Transconductance	g_{FS}	$V_{DS}=-10\text{V}, I_D=-1.4\text{A}$		4.5		S
Diode Forward Voltage	V_{SD}	$I_S=-1.0\text{A}, V_{GS}=0\text{V}$		-0.75	-1.2	V
Dynamic						
Total Gate Charge	Q_g	$V_{DS}=-75\text{V}, V_{GS}=-6\text{V}$ $I_D=-1.0\text{A}$		10	15	nC
Gate-Source Charge	Q_{gs}			2.5		
Gate-Drain Charge	Q_{gd}			5.0		
Input Capacitance	C_{iss}	$V_{DS}=50\text{V}, V_{GS}=0\text{V}$ $f=1\text{MHz}$		520		pF
Output Capacitance	C_{oss}			30		
Reverse Transfer Capacitance	C_{rss}			20		
Turn-On Time	$t_{d(on)}$	$V_{DD}=-75\text{V}, R_L=75\Omega$ $I_D=-1.0\text{A}, V_{GEN}=-10\text{V}$ $R_G=1.0\Omega$		10	20	ns
	t_r			12	25	
Turn-Off Time	$t_{d(off)}$			30	60	
	t_f			12	25	



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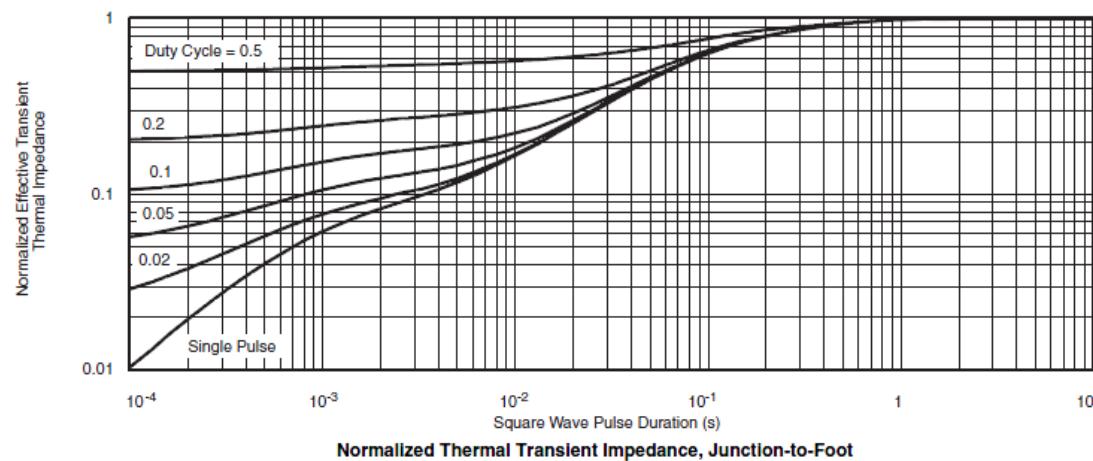
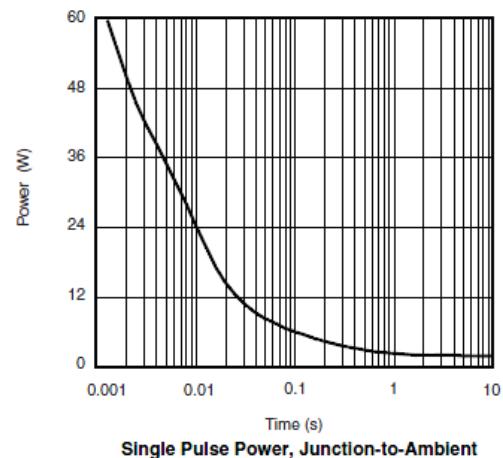
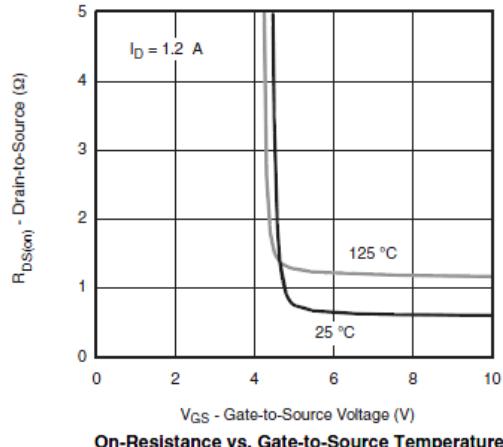
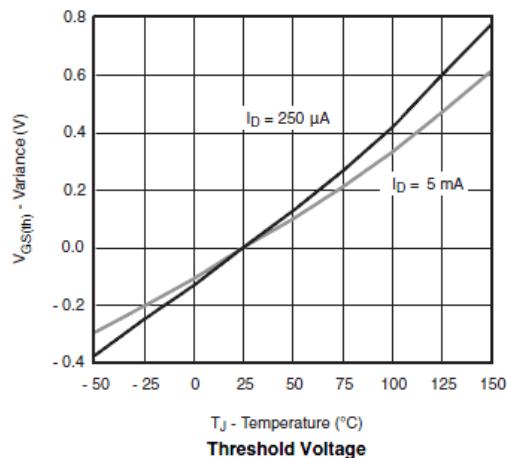
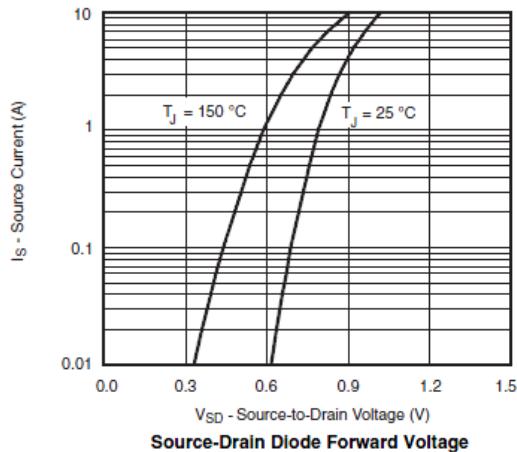
**AFP2325S
150V P-Channel
Enhancement Mode MOSFET**

Typical Characteristics





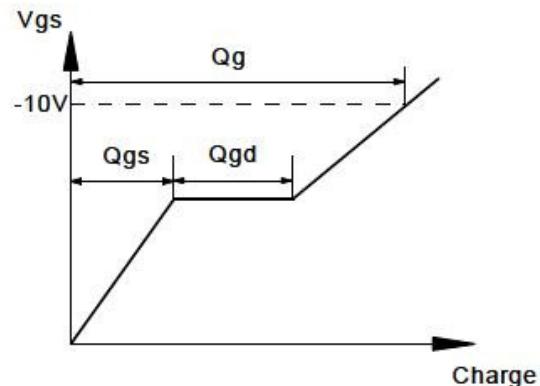
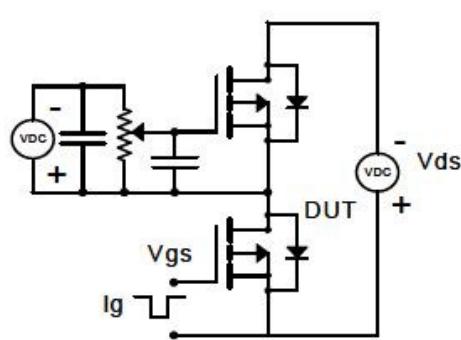
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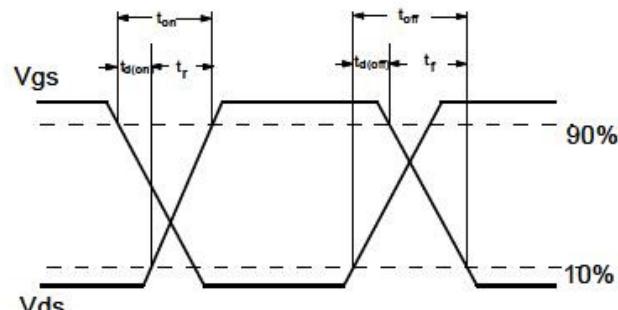
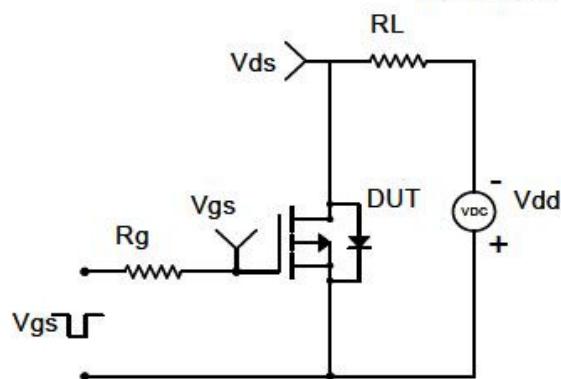


Typical Characteristics

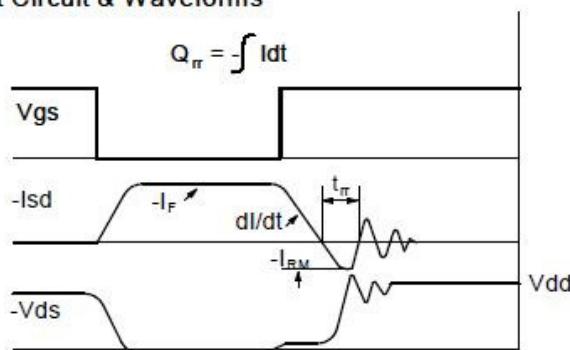
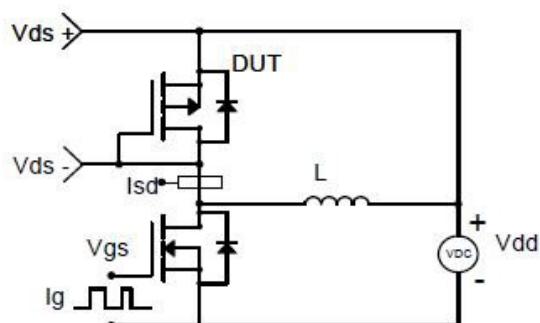
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms

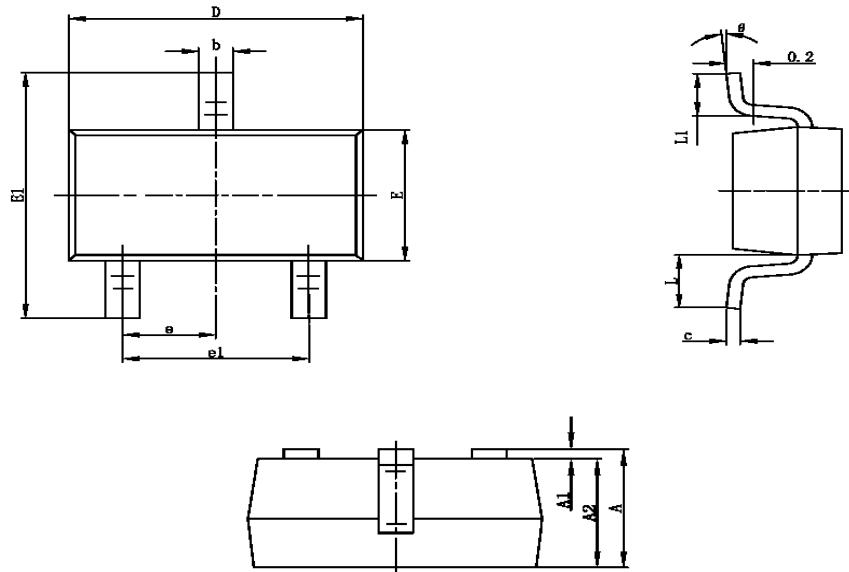




**Alfa-MOS
Technology**

**AFP2325S
150V P-Channel
Enhancement Mode MOSFET**

Package Information (SOT-23-3L)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.400	0.012	0.016
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.700REF		0.028REF	
L1	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

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